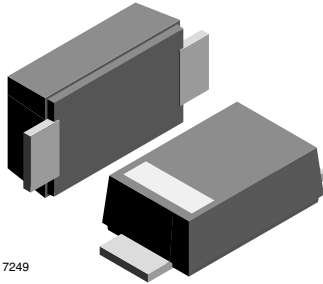




Fast Rectifier Surface Mount



FEATURES

- For surface mounted applications
- Low profile package
- Ideal for automated placement
- Glass passivated
- High temperature soldering: 260 °C/10 s at terminals
- Wave and reflow solderable
- AEC-Q101 qualified
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC



RoHS COMPLIANT

MECHANICAL DATA

Case: DO-219AB (SMF)

Polarity: band denotes cathode end

Weight: approx. 15 mg

Packaging codes/options:

GS18/10K per 13" reel (8 mm tape)

GS08/3K per 7" reel (8 mm tape)

Int. construction: single

PARTS TABLE			
PART	ORDERING CODE	MARKING	REMARKS
RS07B	RS07B-GS18 or RS07B-GS08	RB	Tape and reel
RS07D	RS07D-GS18 or RS07D-GS08	RD	Tape and reel
RS07G	RS07G-GS18 or RS07G-GS08	RG	Tape and reel
RS07J	RS07J-GS18 or RS07J-GS08	RJ	Tape and reel
RS07K	RS07K-GS18 or RS07K-GS08	RK	Tape and reel

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
Maximum repetitive peak reverse voltage		RS07B	V _{RRM}	100	V
		RS07D	V _{RRM}	200	V
		RS07G	V _{RRM}	400	V
		RS07J	V _{RRM}	600	V
		RS07K	V _{RRM}	800	V
Maximum RMS voltage		RS07B	V _{RMS}	70	V
		RS07D	V _{RMS}	140	V
		RS07G	V _{RMS}	280	V
		RS07J	V _{RMS}	420	V
		RS07K	V _{RMS}	560	V
Maximum DC blocking voltage		RS07B	V _{DC}	100	V
		RS07D	V _{DC}	200	V
		RS07G	V _{DC}	400	V
		RS07J	V _{DC}	600	V
		RS07K	V _{DC}	800	V
Maximum average forward rectified current	T _{tp} = 65 °C		I _{F(AV)}	1.4	A
	T _A = 45 °C		I _{F(AV)}	0.5	A
Peak forward surge current 8.3 ms half sine-wave	T _L = 25 °C		I _{FSM}	30	A



THERMAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Thermal resistance junction to tie point		R _{thJP}	30	K/W
Thermal resistance junction to ambient air ⁽¹⁾		R _{thJA}	180	K/W
Operating junction and storage temperature range		T _j , T _{stg}	- 55 to 150	°C

Note
⁽¹⁾ Mounted on epoxy glass PCB with 3 mm x 3 mm Cu pads (≥ 40 μm thick)

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 0.7 A ⁽¹⁾	RS07B	V _F			1.15	V
		RS07D	V _F			1.15	V
		RS07G	V _F			1.15	V
		RS07J	V _F			1.15	V
			I _F = 1 A ⁽¹⁾	RS07K	V _F		
Maximum DC reverse current at rated DC blocking voltage	T _A = 25 °C	RS07B	I _R			10	μA
		RS07D	I _R			10	μA
		RS07G	I _R			10	μA
		RS07J	I _R			10	μA
		RS07K	I _R			2	μA
	T _A = 125 °C	RS07B	I _R			50	μA
		RS07D	I _R			50	μA
		RS07G	I _R			50	μA
		RS07J	I _R			50	μA
		RS07K	I _R			150	μA
Reverse recovery time	I _F = 0.5 A, I _R = 1 A, I _{rr} = 0.25 A	RS07B	t _{rr}			150	ns
		RS07D	t _{rr}			150	ns
		RS07G	t _{rr}			150	ns
		RS07J	t _{rr}			250	ns
		RS07K	t _{rr}			300	ns
Typical capacitance	4 V, 1 MHz	RS07B	C _j		9		pF
		RS07D	C _j		9		pF
		RS07G	C _j		9		pF
		RS07J	C _j		9		pF
		RS07K	C _j		4		pF

Note
⁽¹⁾ Pulse test: 300 μs pulse width, 1 % duty cycle

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

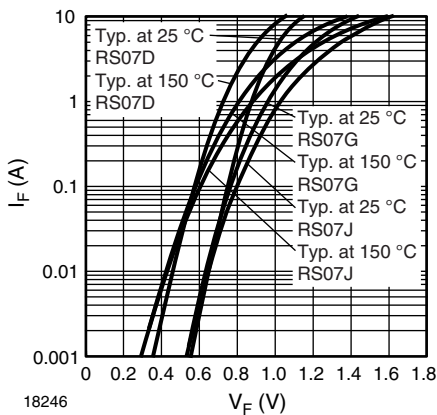


Fig. 1 - Typical Forward Characteristics

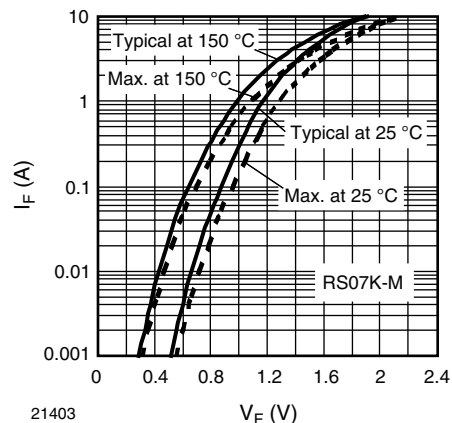


Fig. 2 - Typical Forward Characteristics

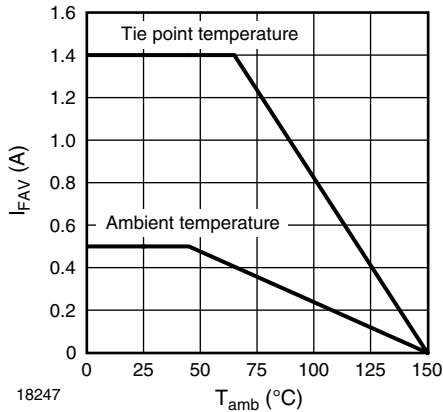


Fig. 3 - Forward Current Derating Curve

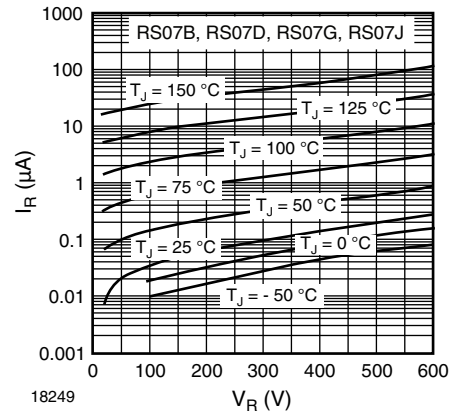


Fig. 6 - Typical Reverse Characteristics

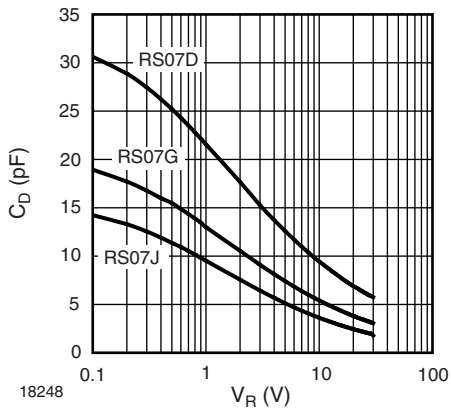


Fig. 4 - Typical Diode Capacitance vs. Reverse Voltage

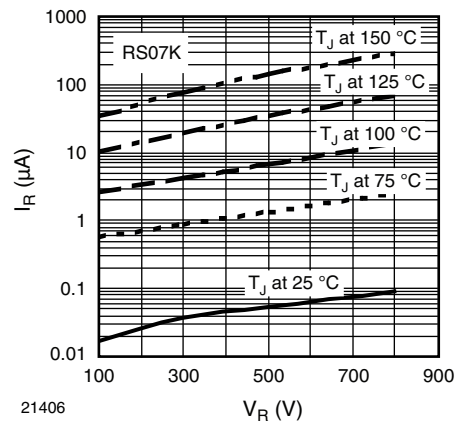


Fig. 7 - Typical Reverse Characteristics

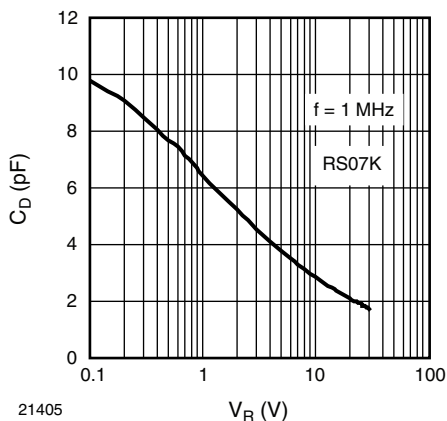
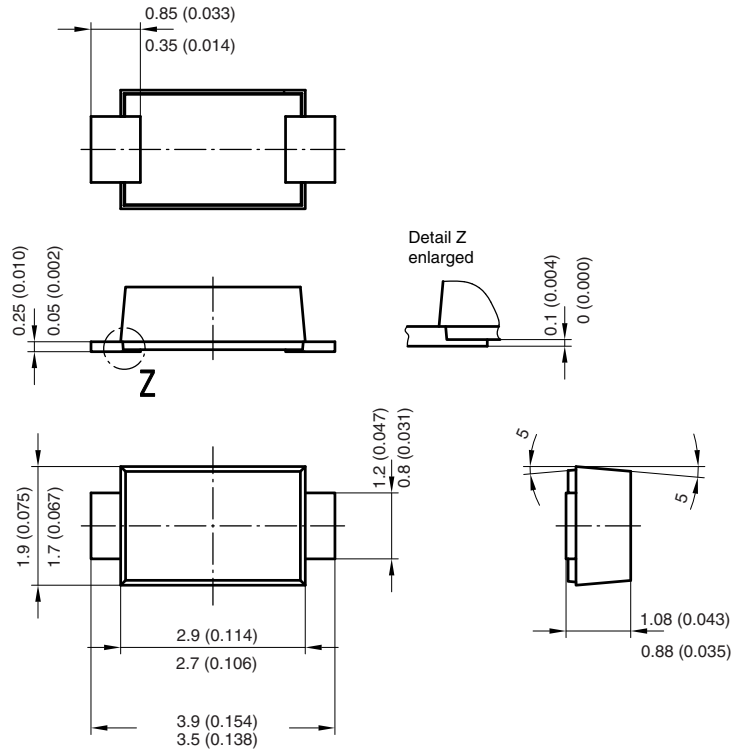


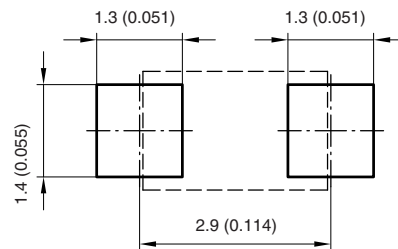
Fig. 5 - Typical Diode Capacitance vs. Reverse Voltage



PACKAGE DIMENSIONS in millimeters (inches): DO-219AB (SMF)



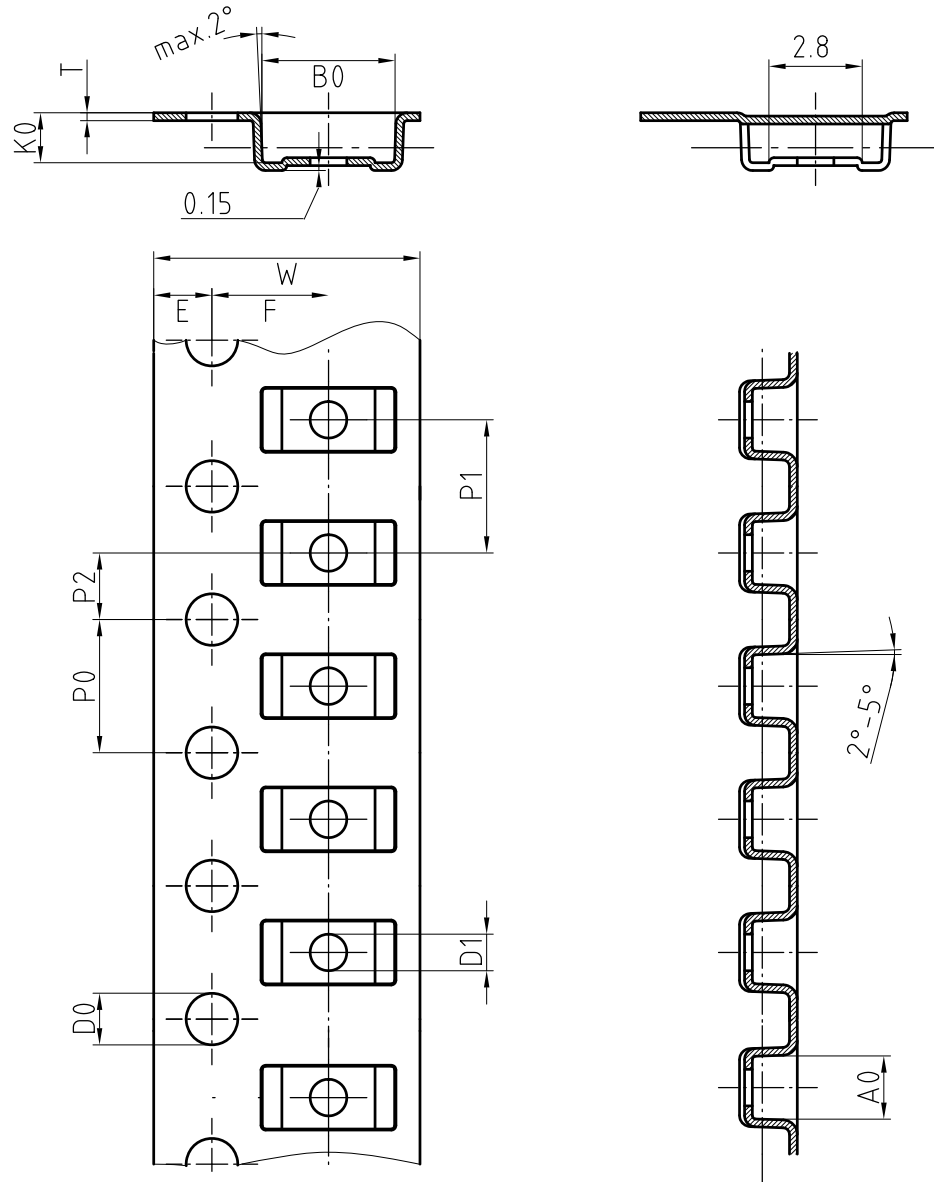
Foot print recommendation:



Created - Date: 15. February 2005
 Rev. 3 - Date: 13. March 2007
 Document no.:S8-V-3915.01-001 (4)
 17247



BLISTERTAPE DIMENSIONS in millimeters: DO-219 AB (SMF)



Mat:	A0	B0	K0	W	T	P0	P2	P1	D0	D1	E	F
PS	1.9	4.0	1.5	8.0	0.235	4.0	2.0	4.0	1.5	1	1.75	3.5

Document-No.: S8-V-3717.02-001 (3)

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